

标准&定制开关连接器产品制造商

DONG GUAN XI BANG ELECTRONICS CO., LTD.

规 格 书 SPECIFICATION

CUSTOMER NAM	客户名	称:			
CUSTOMER NO.	客户编	号:			
SERIES	系	列:	按钮	建开关	
MODEL NO.	型	号:			
DRAWING NO.	图形	号:	Key	Swi tcl	1
- ·	l be basis of or 告此产品规格 并签名和		l record. Thanks 放请确认此规格 司,以作我司产 <u>,多谢合作!</u>	your cooperation 书内所有项目 品制作之	
APPROVE 接受			NOT API	PROVE 不接	受
SIGNATURE 签署 STAMI	P盖章 DA	ATE日期			
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PREPARED BY.制表人 研发部 戴海明 2022. 06. 08	黄	版部 自清 . 06. 08	庞	BY.审核 程部 (军 . 06. 08	APPROVAL BY. 批准 总经办 吴量 2022. 06. 08

东莞市溪榜电子有限公司

Dong guan Xi Bang Electronics Co., Ltd

地址:广东省东莞市黄江镇合路工业区

Address: He Lu Industrial Zone, Huangjiang Town

,Dongguan City, Guangdong Province

Tel: (0769)82055138/82056828

Fax:(0769)83663452

邮箱: admin@alspr.com switch@alspr.com http://www.alpsr.com/ http://www.alpsr.com/

Dong Guan XB ElectronicsCo., Ltd

AccountNumber: 705540238

BankName: CitibankN. A., HongKongBranch

Country/Region: Hong Kong

BankCode: 006

BankAddress: 3GardenRoad, Central, Hong Kong

SWIFT/BIC: CITIHKHX(CITIHKHXXXXX*If11Charactersare

required)

MAiL: HK@ALPSR. CN XB@ALPSR. CN Quality core! Afterburner for Made in China!

規 格 書 SPECIFICATION

SERIES 系列:TACT SWITCH

MODEL NO. 型號:

1. RATING 額定值: 0. 3A 12V DC LED:12V

CIRCUIT 回路:
 TIMING 切換類型:

4. STANDARD TEST TEMPERATURE SHALL BE 5°C TO 35°C AND HUMIDITY SHALL BE 45% TO 85% .

溫度 5~35℃, 濕度 45~85% 標准狀態下測試。

5. OPERATING TEMPERATURE RANGE IS -16°C TO 60°C. IT IS USUALLY APPLIED TO ELECTRONIC AND ELECTRICAL APPLIANCE PRODUCTS.

溫度 -16℃~60℃ 環境內使用。一般適用於電子、電氣方面產品使用。

IT	EM 項目	TEST CONDITION 測試條件	PERFORMANCE 性能
		6. ELECTRONICAL PERFORMANCE 電氣	性能
6. 1	CONTACT RESISTANCE 接觸電阻	Being tested at 1 kHz small current and voltage (100mA,20mV) by contact resistance meter. 在 1kHz 小電流電壓(100mA,20mV)下測量。	100 mΩ max. 100毫歐 以下。
6. 2	INSULATION RESISTANCE 絕緣電阻	DC 500 V shall be applied for test between terminals and between terminals and frame for one minute. 在端子之間和端子與殼之間加 DC 500 V 條件下,持續1分鐘測量。	100MΩ min. 100兆歐 以上。
6. 3	WITHSTAND VOLTAGE 耐電壓	AC 250 V and induction current 1 mA shall be applied for test between terminals and between terminals and frame for one minute. 在端子之間和端子與殼之間加 AC 250 V (50Hz或60Hz) 感應電流 1mA 條件下,持續1分鐘測量。	There shall be no breakdown. 無擊穿現象出現。
6. 4	BOUNCING 觸點反跳	By punching slightly the top of switch in normal operating condition after connection to the measuring circuit below, measur the bounce at ON and OFF position. 開闢按照以下測定回路,在開闢中央施加通常使用狀態的操作力,對開闢ON時和OFF時進行時間測定. ———————————————————————————————————	10ms max. ≤10 ms. t:bounce time

ITEM 項目		TEST CONDITION 測試條件	PERFORMANCE 性能
		7. MECHANICAL PERFORMANCE 機械性	生能
7. 1	OPERATING FORCE 動作力	PUSH FORCE RETURN FORCE TRAVEL Place the switch vertically to the operation direction, impress force to the centre of knob, and test the maximun force of onstate. 開關垂直於操作方向放置,在推杆中心逐漸施力,測量開關導通所需的最大力度。	Push Force:160±50gf Return Force:65gf min.
7. 2	TERMINAL STRENGTH 端子強度	A static force of 300 g being applied in one direction on the tip of the terminal for l minute. 一個 300 克之靜負荷施加於端子頂部的一個方向持續1分鐘。	There shall be no sign of mechanical and electrical damage. 無任何跡象顯示機械及電器性能之損壞。
7. 3	KNOB STRENGTH 推杆強度	Placing the switch such that the direction of switch operation is vertical and then a below static load shall be applied in the direction of stem operation. 開闢垂直與操作方向放置,推扞可承受以下靜荷重。 (1) Depression 施加力: 30 N (2) Duration 時間: 15 s (3) Number of times 次數: 1 times	
		8. DURABILITY 耐久性	
8. 1	SOLDERING TEST 可焊性試驗	The tip of the terminals shall be dipped 2 mm in the solder bath within temperature of 250±5°C for 3 seconds. 端子頂部被浸入焊錫池 2mm 深,溫度250±5°C, 時間3秒。 The condition mentioned is temperature for lead-free soldering. 無鉛錫測試 Alloy:Sn 96.5% Cu 3% Ag 0.5% 成份: 錫 96.5% 銅 3% 銀 0.5%	Over 95% of the immersed surface was covered by tin. 浸入的部份95%以上表面將被錫覆蓋。
8. 2	SOLDERING RESISTANT TEST 耐焊性試驗	Manual soldering temperature 350±5℃, soldering time 3±0.5 seconds, however excessive pressure shall not be applied to the terminal. 手焊接的時候溫度需控制在350±5℃, 時間為 3±0.5秒, 但不能在端子上施加異常壓力。 The condition mentioned is temperature for lead-free soldering. 無鉛錫測試。 Alloy:Sn 96.5% Cu 3% Ag 0.5% 成份: 錫 96.5% 銅 3% 銀 0.5%	Without deformation of case or excessive looseness of teminals, meet mechanical and electrical properties 本體無變形,能滿足於機械、電器性能.

ITI	EM 項目	TEST CONDITION 浿	試條件	PERFORMANCE 性能	
8. 3	REFLOW SOLDERING HEAT TEST 回流焊接熱試驗	Temperature (℃) 180℃ 2±0.3min(pre-heating) 3 to 4min. time inside soldering equipment *Temperature means The temperature of *PC board thickness for 1.0 mm *溫度指PC板表面的溫度 *PC板厚度为1.0毫米 The condition mentioned is temperature 無鉛錫測試。 Alloy:Sn 96.5% Cu 3% Ag 0.5% 成份: 錫 96.5% 銅 3% 銀 0.5% 回流焊次數: 1次	260°C max.(3 Sec max.) 230°C Time 40s max.	Without deformation of case or excessive looseness of teminals, meet mechanical and electrical properties 本體無變形,能滿足於機械、電器性能.	
8. 4	LIFE TEST 壽命測試	100,000 cycles of operation at a rate of 30-60 cycles per minute with unloading 無負載條件下,每分鐘 30-60 次的速度 操作100,000次。		 (1) Contact resistance 200mΩ max. 接觸電阻200毫歐以下 (2) Operating force 30% initial value 動作力變化範圍初始值30% (3) ITEM 項目—6. 2 (4) ITEM 項目—6. 3 	
8. 5	MOISTURE RESISTANT TEST 耐濕試驗	40±2℃ 90-95% RH for 96 hours.test after keeping in normal condition for 30 minutes. 在40±2℃ 90-95% RH 環境中放96小時, 再放在正常環境中, 30分鐘後進行測試。		 (1) Contact resistance 200mΩ max. 接觸電阻200毫歐以下 (2) Insulation resistance 	
8. 6	COLD RESISTANT TEST 耐冷試驗	At -40±3°C for 96 hours, test after keepi normal condition for 30minutes. 在 -40±3°C 環境中放96小時,再置方常環境中,30分鐘後進行測試。		50 MΩ min. 絕緣電阻50兆歐以上 (3) ITEM 項目—6.3 (4) ITEM 項目—7.1	

	EM 項目	TEST CONDITION 測試條件	PERFORMANCE 性能
	HEAT	85±2°C for 96 hours,test after keeping in normal	
	RESISTANT	condition for 30 minutes.	(1) Contact resistance
8. 7	TEST	在 85±2℃ 環境中放96小時,再放在正常環境	$200 \mathrm{m}\Omega$ max.
耐熱試驗		中30分鐘後進行測試。	接觸電阻200毫歐以下
101 2777 HSA-6-277	, , , , , , , , , , , , , , , , , , ,	(2) Insulation resistance	
		According to following figure,after 5 cycles, test after keeping in normal condition for 30 minutes. 如圖示之環境中,循環5次後,再置於正常環	50 MΩ min. 絕緣電阻50兆歐以上 (3) ITEM 項目—6.3 (4) ITEM 項目—7.1
	TEMPERATURE	境中,30分鐘後進行測試。	
8.8	CYCLING		
	TEST	+85°C	
	溫度交 變試驗	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	
8. 9	STORAGE ENVIROMENT 儲存環境	Under sealing pack condition, stored temperature don't exceed 30℃ and relative humidity is 75% RH; in the enviroment of no sunshine direct and no corrosive gas, the stored time ought to be three months but within six month at most. 密封包裝狀態下,儲存溫度為≪30℃,相對溫度75% RH;,無陽光直射,無腐蝕性氣體的環境中,儲存時間為3個月,最長不宜超過6個月。Without sealing pack condition, stored temperature don't exceed 30℃ and relative humidity is 75% RH; in the enviroment of no sunshine direct and no corrosive gas, the stored time shouldn't exceed 48H 無密封包裝狀態下,儲存溫度為≪30℃,相對溫度75% RH;,無陽光直射,無腐蝕性氣體的環境中,儲存時間最長不宜超過48小時。Don't excessive overlap or overstocking when keeping this goods, in case of damage. 保存時應注意物品不能過量重疊、積壓、以免損壞	